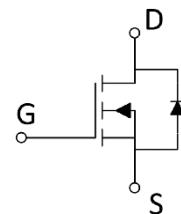
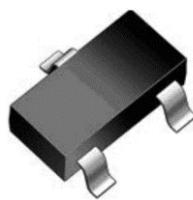


30V_{DS} N-Channel Enhancement Mode MOSFET

Features

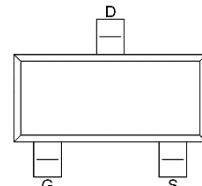
SOT23

- V_{DS}=60V, I_D=3A
- R_{DS(ON)}=105mΩ (TYP.) V_{GS}=10V
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance



Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion



Ordering Information

Device	Package		Marking	Package Qty.
HMN2308	SOT-23	Pb-Free	S8	3000pcs/Reel

Absolute Maximum Ratings (T_C=25°C,unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	60	V
Gate-Source Voltage (V _{GS} =0V,static)	V _{GS}	±20	V
Continuous Drain Current (T _C =25°C)	I _D	3	A
Continuous Drain Current (T _C =100°C)		0.9	A
Maximum Power Dissipation (T _C =25°C)	P _D	0.35	W
Operating,Storage Temperature Range	T _{J,T_{STG}}	-55~150	°C

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	R _{θJC}	-	60	-	°C/ W
Thermal Resistance,Junction-to-Ambient	R _{θJA}	-	125	-	°C/ W

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V	-	-	1	μA
Gate -Source Leakage Current	I _{GSS}	V _{GS} =±12V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} ,I _D =250μA	0.5	-	2	V
Drain-Source On-stage Resistance	R _{DS(ON)}	V _{GS} =10V,I _D =2.8A	-	82	105	mΩ
		V _{GS} =4.5V,I _D =2.5A	-	91	130	

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C _{iss}	V _{DS} =15V V _{GS} =0V f=1MHz	-	247	-	pF
Output capacitance	C _{oss}		-	34	-	
Reverse transfer capacitance	C _{rss}		-	20	-	
Total Gate Charge	Q _g	V _{DS} =15V V _{GS} =4.5V I _D =5.8A	-	6	-	nC
Gate Source Charge	Q _{gs}		-	1	-	
Gate Drain Charge	Q _{gd}		-	1.3	-	
Turn-on delay Time	t _{d(on)}	V _{GS} =10V V _{DS} =15V R _L =2.7Ω R _G =3Ω	-	6	-	ns
Rise time	t _r		-	15	-	
Turn-off delay Time	t _{d(off)}		-	15	-	
Fall time	t _f		-	10	-	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _{SD} =1A	-	0.8	1.2	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V,I _{SD} =5A	-	16	-	ns
Reverse Recovery Charge	Q _{rr}	d _i /d _t =100A/μs	-	9	-	nC

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